

ABSTRACT OF THE DISCLOSURE

The housing used in the electronic apparatus has an outer wall. The outer wall is formed by injecting a metal material from a plurality of gates into a molding space in a metal die. The outer wall includes a first end portion situated on an upstream end along a flowing direction of the metal material, a second end portion situated on a downstream end of the flowing direction of the metal material, and an injection portion formed on the first end portion where the plurality of gates of the metal die are situated, forming a space between the first end portion and the injection portion.

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